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(12) **United States Design Patent** (10) **Patent No.:** **US D929,378 S**
Li (45) **Date of Patent:** **** Aug. 31, 2021**

(54) **EARPHONES**

(71) Applicant: **STB INTERNATIONAL LIMITED,**
Hong Kong (CN)

(72) Inventor: **Junfeng Li,** Shenzhen (CN)

(73) Assignee: **STB INTERNATIONAL LIMITED,**
Hong Kong (CN)

(**) Term: **15 Years**

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Related U.S. Application Data

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(51) **LOC (13) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/223, 205; D24/174; D13/108;
381/380, 381; 128/864, 865, 866;
455/90.3, 575.1, 569.1

CPC H04R 1/10; H04R 25/00; H04R 25/02;
H04R 1/1016; H04R 1/1066; H04R
5/033; H04R 5/0335; H04R 1/1091; H02J
7/0044; H02J 7/0045

See application file for complete search history.

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Primary Examiner — Paula Allen Greene

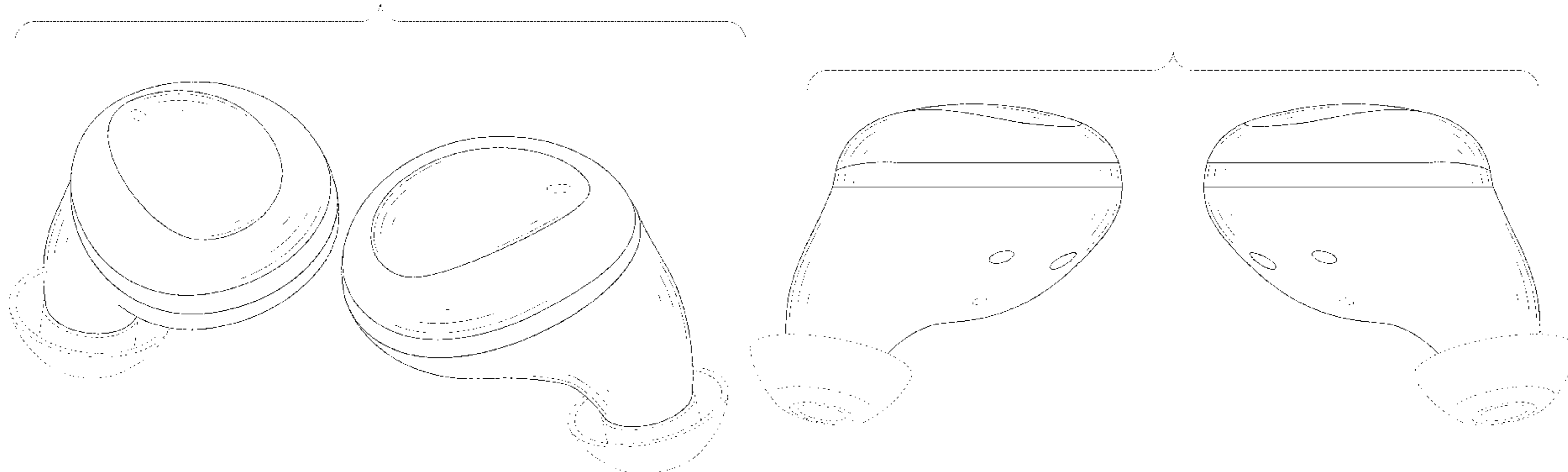
(57) **CLAIM**

The ornamental design for earphones, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of earphones showing my new design;
FIG. 2 is another perspective view thereof;
FIG. 3 is a front elevational view thereof;
FIG. 4 is a rear elevational view thereof;
FIG. 5 is a left side elevational view thereof;
FIG. 6 is a right side elevational view thereof;
FIG. 7 is a top plan view thereof; and,
FIG. 8 is a bottom plan view thereof.
The broken lines in the drawings depict portions of the earphones that form no part of the claimed design.

1 Claim, 8 Drawing Sheets



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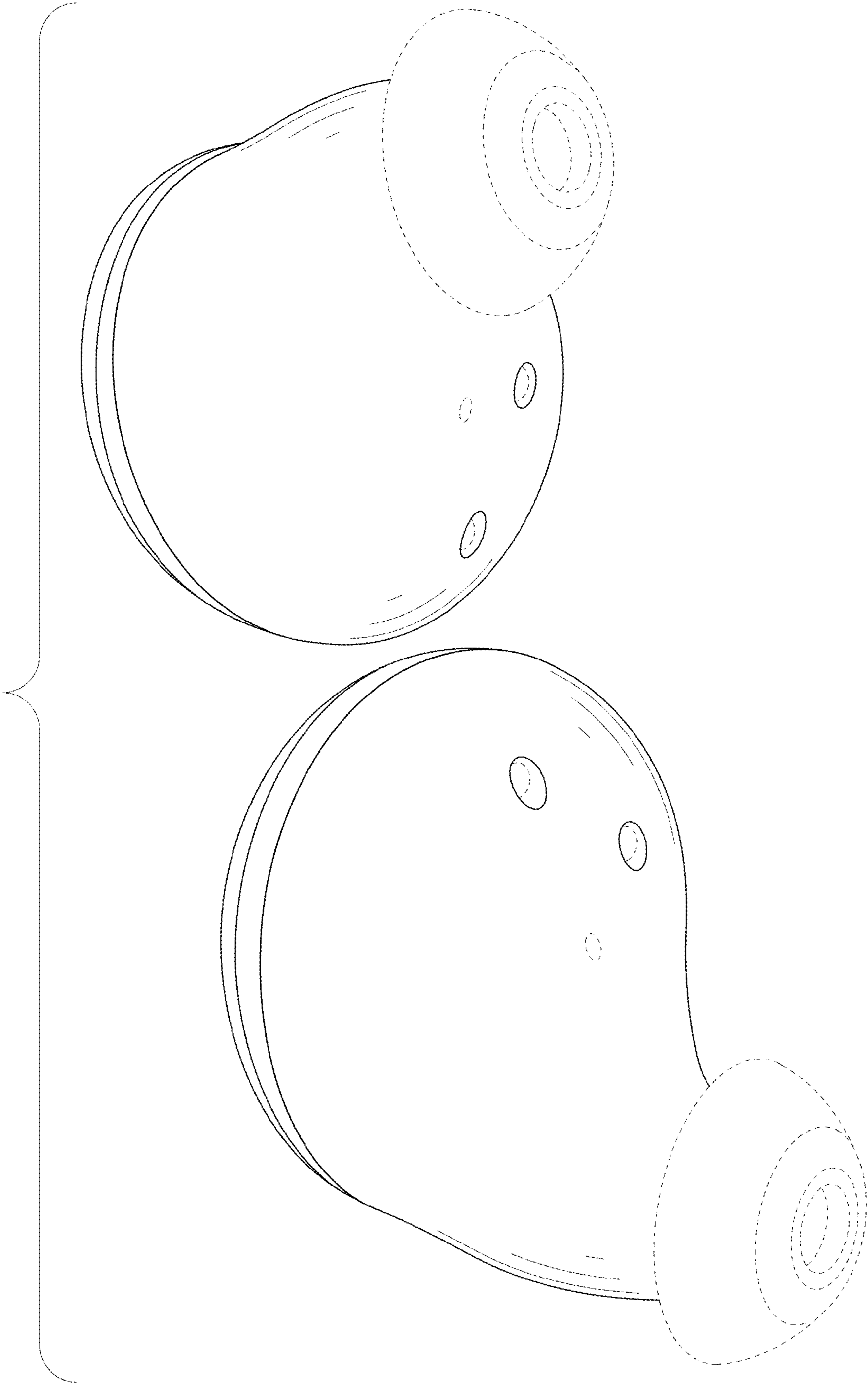


FIG. 1

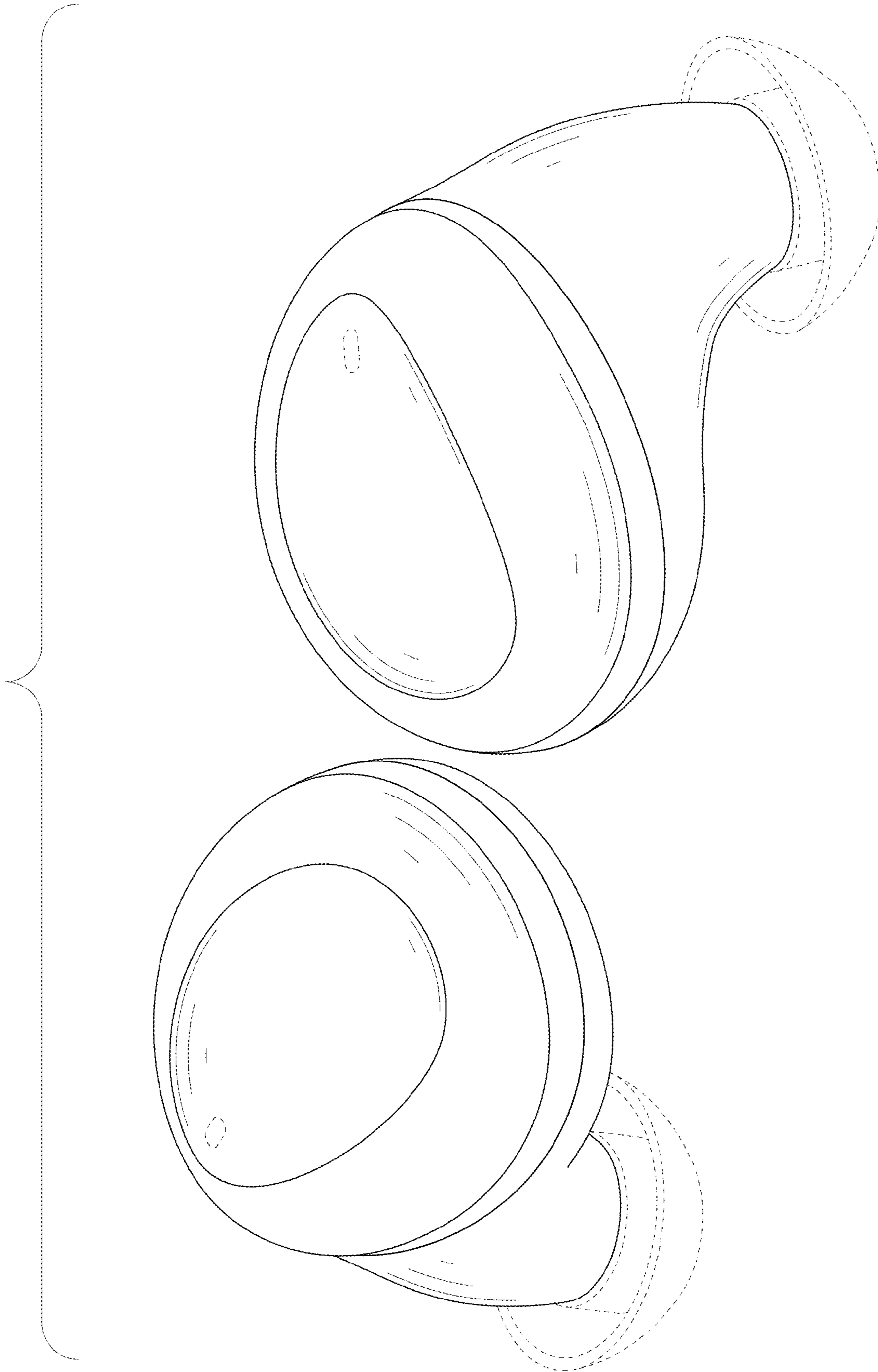


FIG. 2

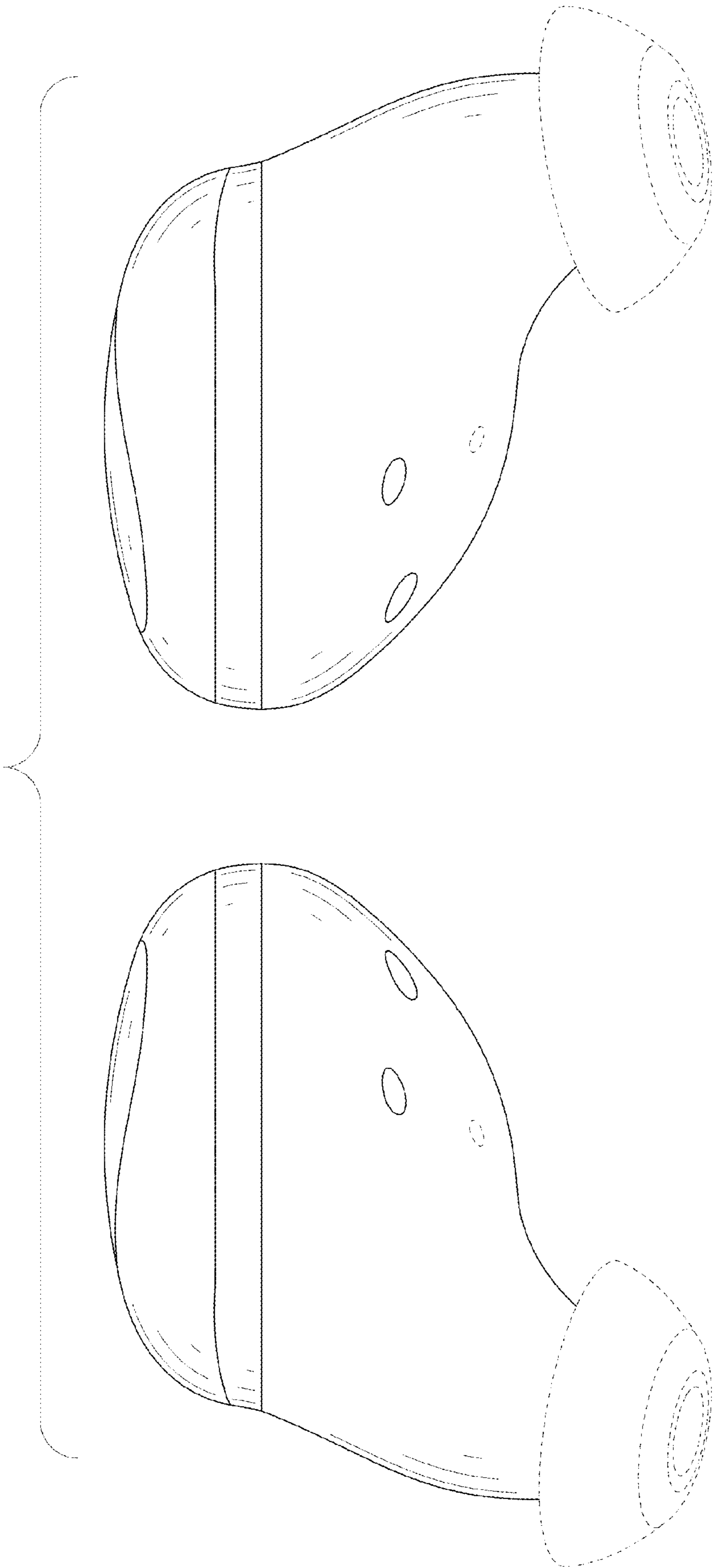


FIG. 3

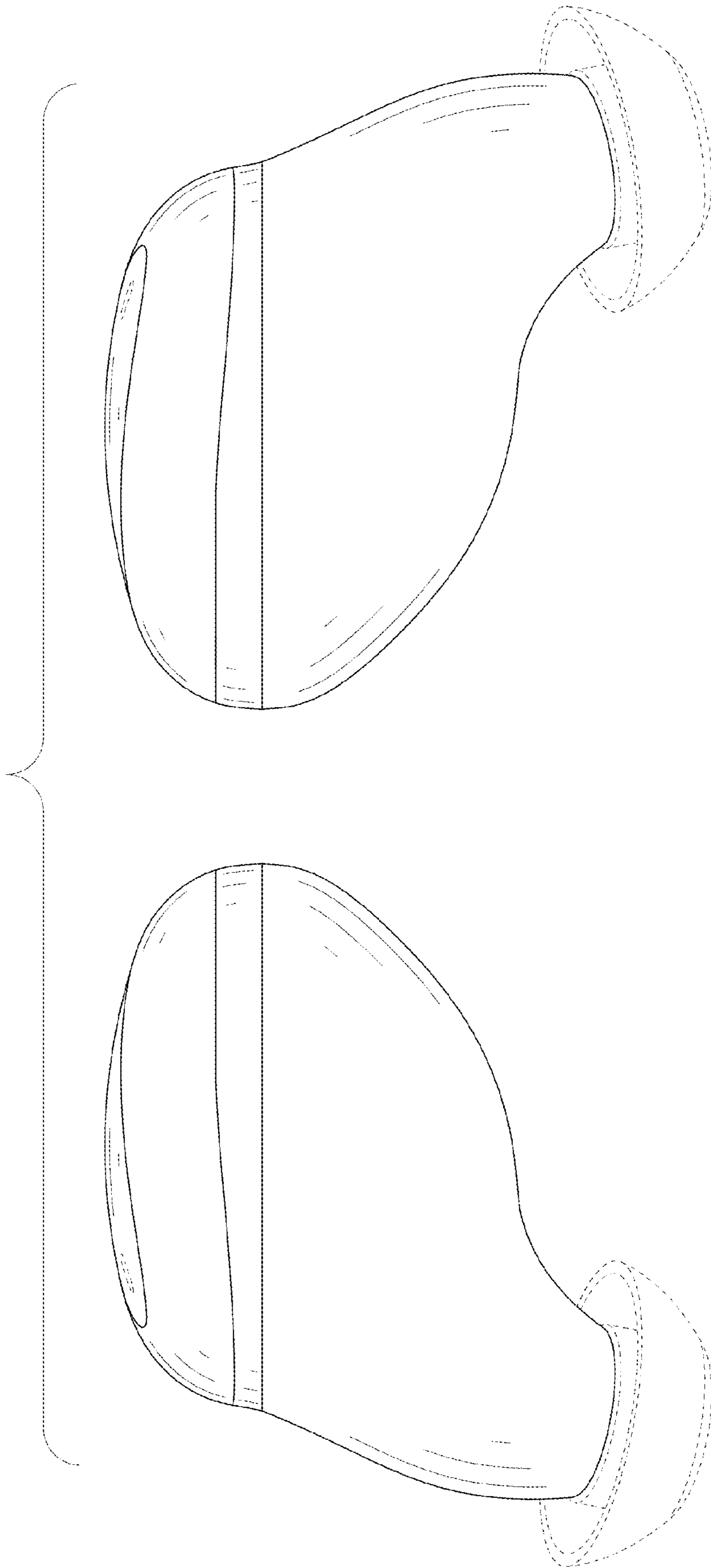


FIG. 4

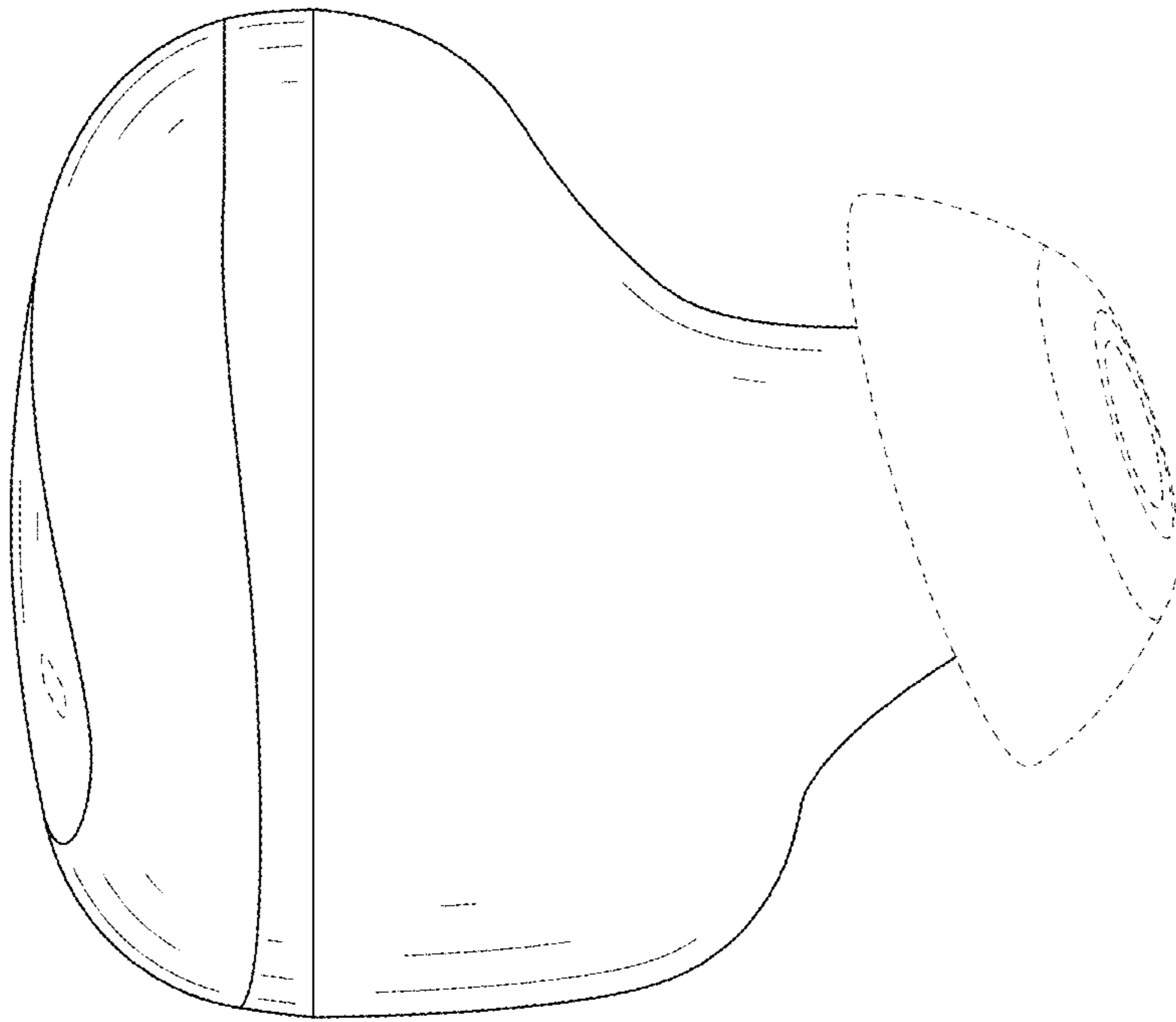


FIG. 5

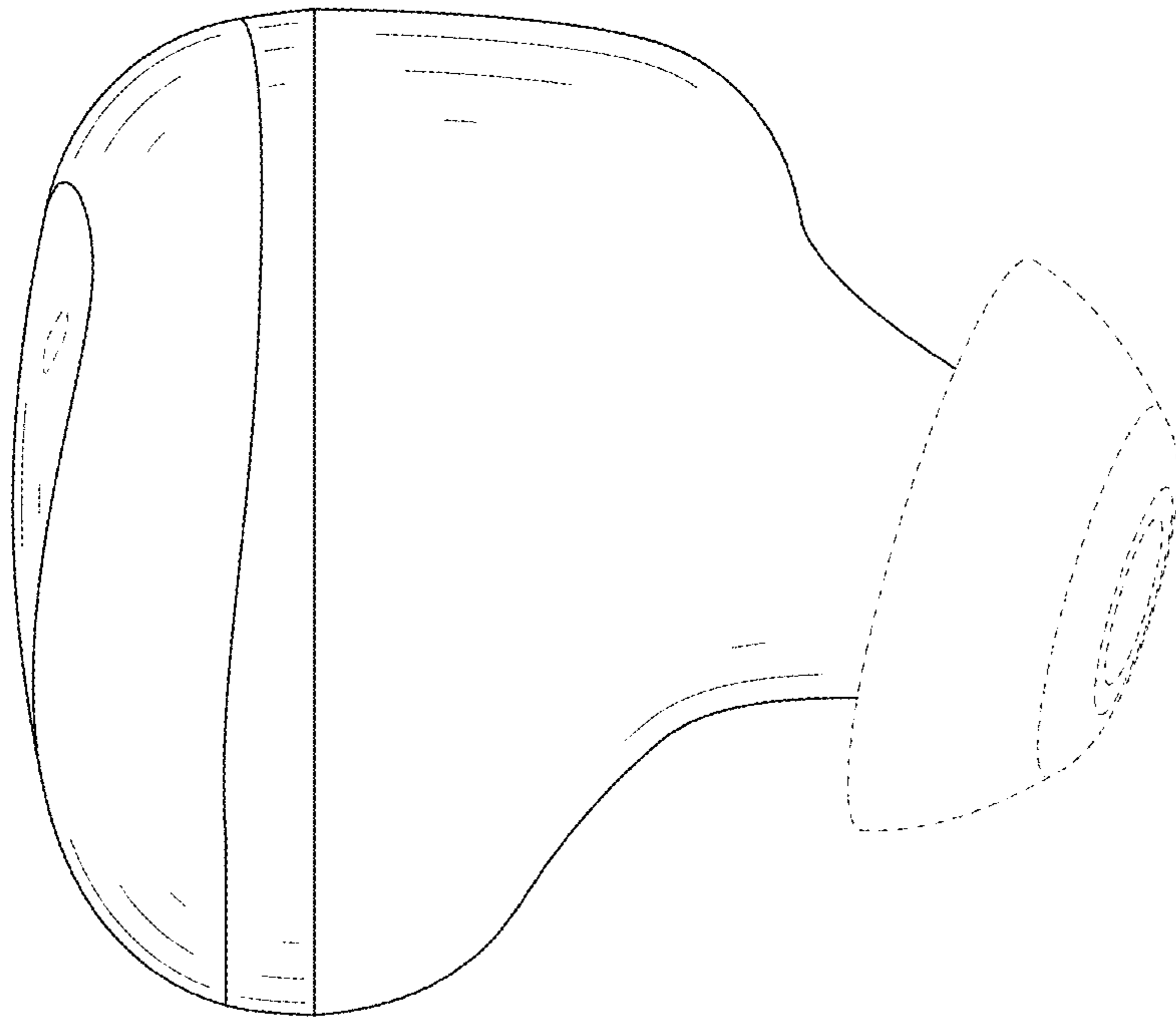


FIG. 6

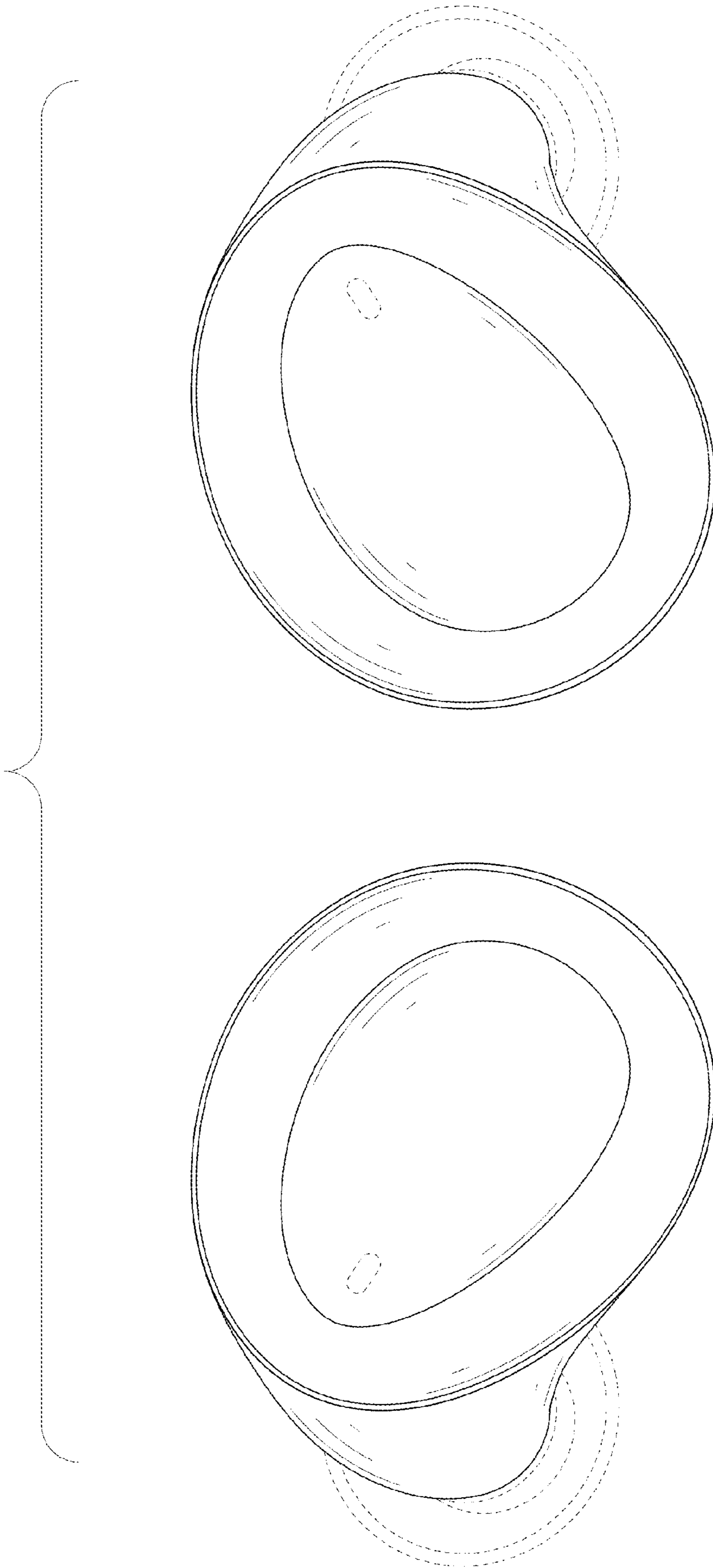


FIG. 7

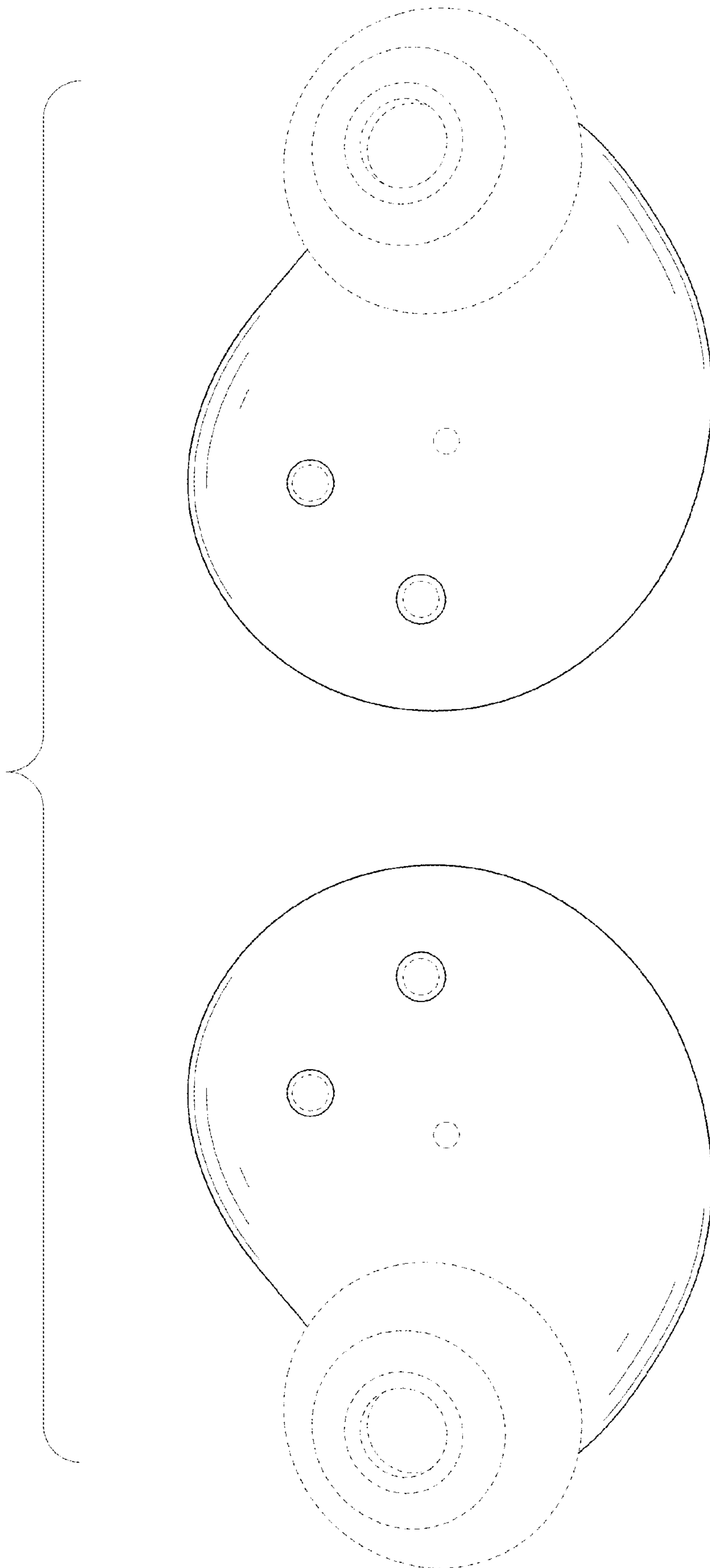


FIG. 8